PNP Built-in Resistor Transistor TO–92 Series Inverter, Driver, Switching

HITACHI

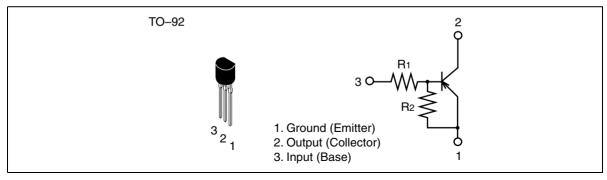
ADE-208-1446B (Z)

Rev.2 Sep. 2001

Features

- Built–in Resistor Type
- Simplifies Circuit Design
- Reduces Board Space
- Complementary pair with BRC144ETP series

Outline



Note: Input resistance is shown in below

Device	R1 (kΩ)	R2 (kΩ)
BRA144ETP	47	47
BRA124ETP	22	22
BRA114ETP	10	10
BRA143ETP	4.7	4.7
BRA123ETP	2.2	2.2



Absolute Maximum Ratings

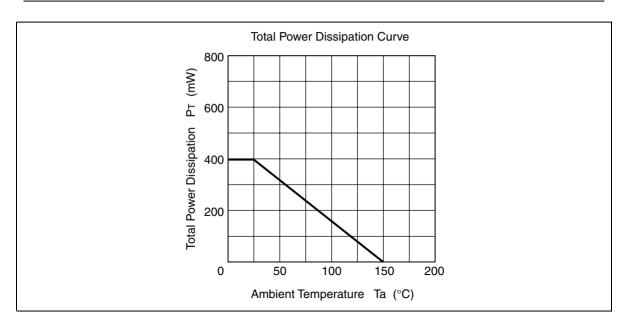
 $(Ta = 25^{\circ}C)$

Item		Symbol	Ratings	Unit	
Supply voltage		V _{cc}	-50	V	
Input voltage	BRA144ETP	V _i	+10 to -50	V	
	BRA124ETP		+10 to -50		
	BRA114ETP		+10 to -50		
	BRA143ETP		+10 to -35		
	BRA123ETP		+10 to -24		
Output current		I _o	-100	mA	
Total power dissip	oation	P _T	400	mW	
Storage temperat	ure	Tstg	-55 to +150	°C	

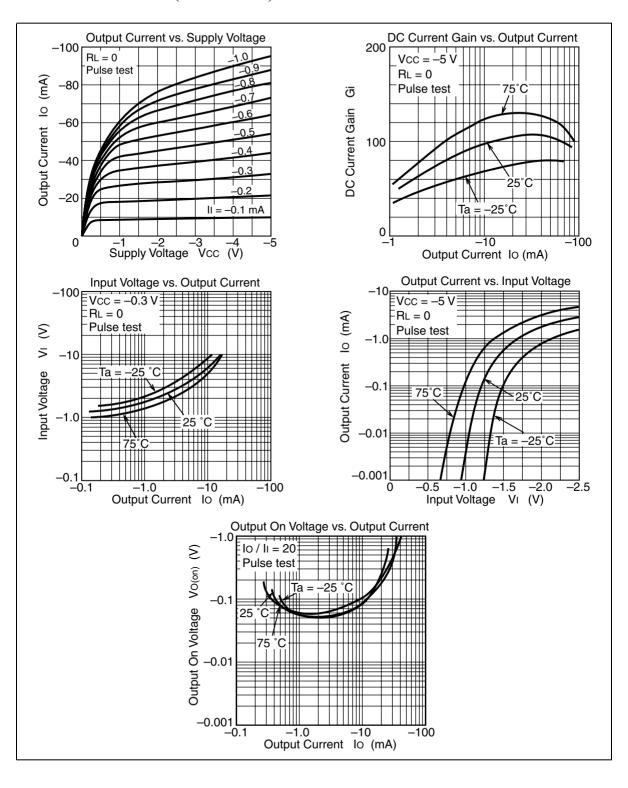
Electrical Characteristics

 $(Ta = 25^{\circ}C)$

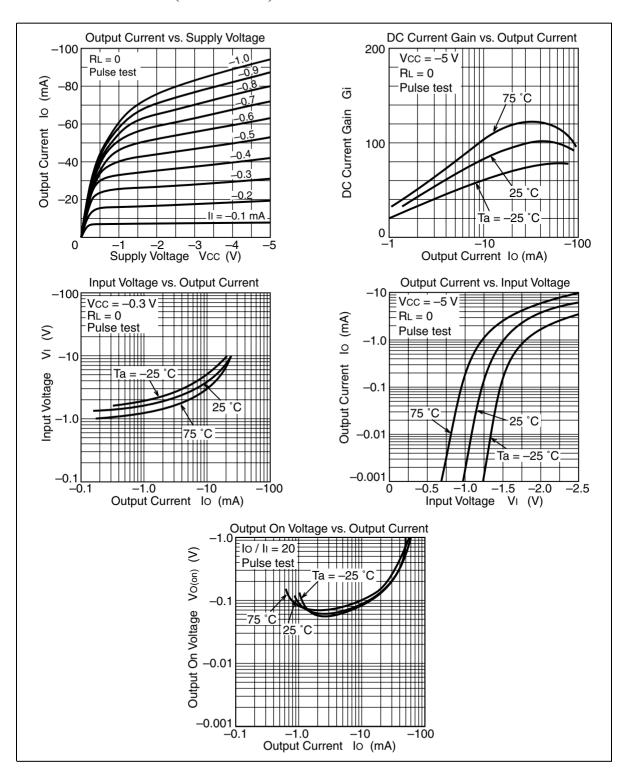
Item		Symbol	Min	Тур	Max	Unit	Test conditions
Input on voltage	BRA144ETP	V _{I(on)}	-1.5	_	-4.5	V	$V_{cc} = -0.3 \text{ V},$ $I_{o} = -5 \text{ mA}$
	BRA124ETP		-1.3	_	-3.0		
	BRA114ETP		-1.2	_	-2.4		
	BRA143ETP	_	-1.1	_	-2.0		
	BRA123ETP	_	-1.1	_	-1.8	_	
Input off voltage	BRA144ETP	$V_{I(off)}$	-1.0	_	-1.5	V 	$V_{cc} = -5 \text{ V},$ $I_{o} = -100 \mu\text{A}$
	BRA124ETP	_	-1.0	_	-1.5		
	BRA114ETP	_	-1.0	_	-1.5		
	BRA143ETP	_	-1.0	_	-1.5		
	BRA123ETP	_	-1.0	_	-1.5		
Output saturation	n current	$V_{O(on)}$	_	_	-0.3	V	$I_{o} = -10 \text{ mA},$ $I_{i} = -0.5 \text{ mA}$
Output cutoff cur	rent	I _{O(off)}	_	_	-0.5	μΑ	$V_{cc} = -50 \text{ V}, I_{i} = 0$
DC current transfer ratio	BRA144ETP	Gi	70	_	_		$V_{cc} = -5 \text{ V}, I_{o} = -5 \text{ mA}$
	BRA124ETP	- - -	56	_	_		
	BRA114ETP		30	_	_		
	BRA143ETP		20	_	_		$V_{cc} = -5 \text{ V}, I_{o} = -10 \text{ mA}$
	BRA123ETP		20	_	_		$V_{cc} = -5 \text{ V}, I_{o} = -20 \text{ mA}$
Input resistance	BRA144ETP	R, -	33	47	61	kΩ 	
	BRA124ETP		15	22	28		
	BRA114ETP		7	10	13		
	BRA143ETP	_	3.3	4.7	6.1		
	BRA123ETP		1.5	2.2	2.8		
Resistance ratio		R ₁ /R ₂	0.8	1.0	1.2		



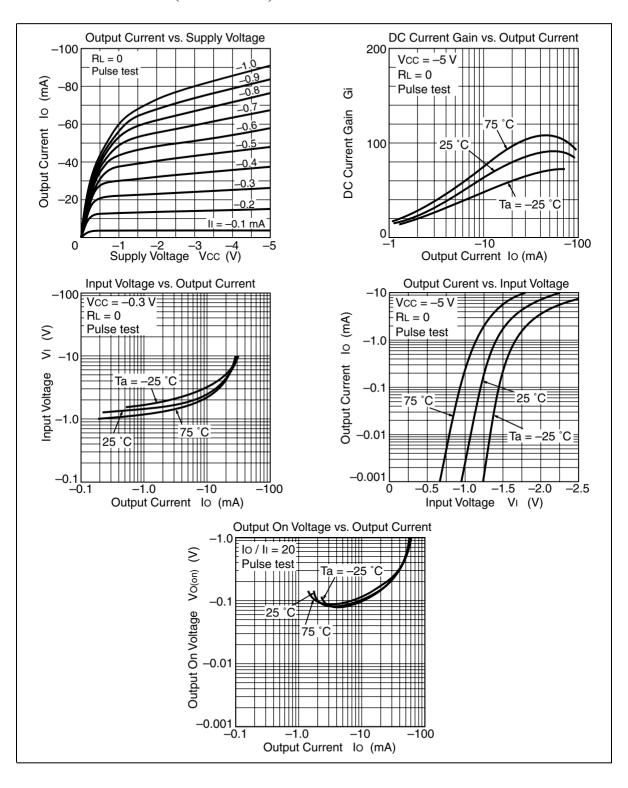
Main Characteristics (BRA144ETP)



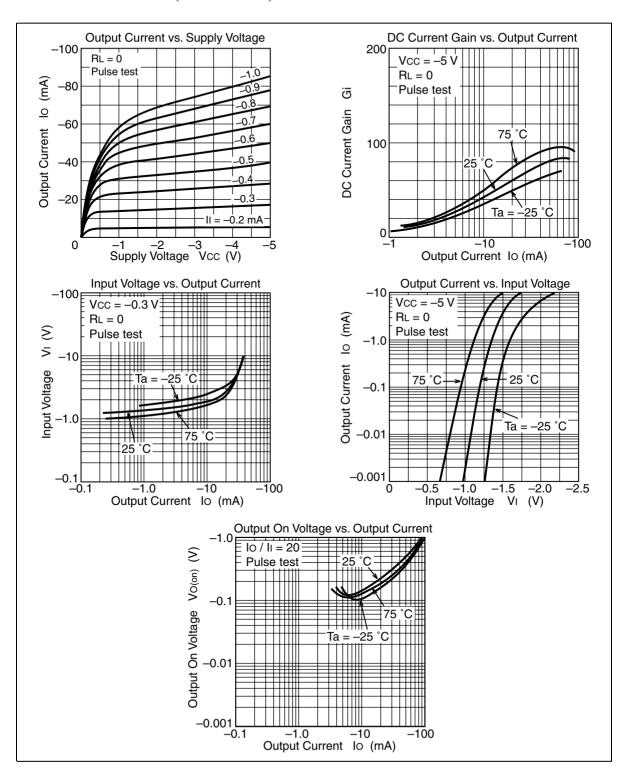
Main Characteristics (BRA124ETP)



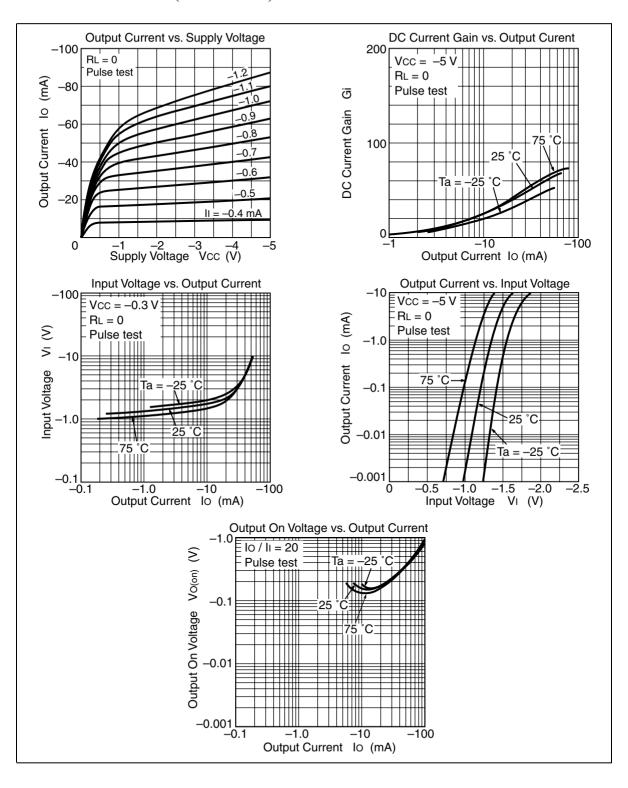
Main Characteristics (BRA114ETP)



Main Characteristics (BRA143ETP)



Main Characteristics (BRA123ETP)

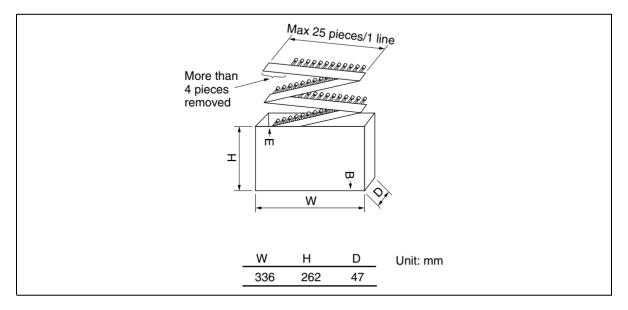


Taping Specification

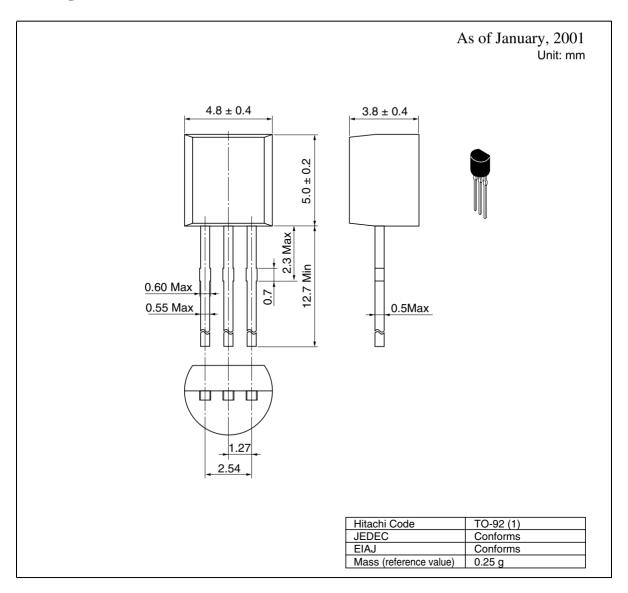
Purchasing Identification Code: Type No. + Grade + TZ

The tape is held in every 25 pitches to a hold box.

Packing quantity is 2500 pieces.



Package Dimensions



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